## SIEMENS

## Data sheet

## 6AV7880-0BB12-2DA2

SIMATIC ITP1000, 8 function keys, Ethernet 10/100/1000 Mbit/s, 1x RS232, 2x USB 3.0, 1x UAJ, 1x USB type-C, 1x SD card reader, Wifi 802.11 a/b/c/g, Bluetooth, Lithium-ion battery; 10" Multitouch (1280 x 800); camera on the rear side, 5 megapixel; 512 GB SSD; Windows 7 Ultimate 64 bit SP1, MUI (de, en, fr, es, it); Core I5-6442EQ; 16 GB RAM; 110/230 V AC power supply unit, Power supply cable for USA; without software (included);

General information	
Design of the programming device	Tablet PC
Display	
Design of display	10" multi-touch
Resolution (pixels)	
<ul> <li>Horizontal image resolution</li> </ul>	1 280 pixel; 1 920 pixels
<ul> <li>Vertical image resolution</li> </ul>	800 pixel; 1 200 pixels
General features	
Luminance	220 cd/m²; 350 cd/m²
Backlighting	
<ul> <li>Type of backlighting</li> </ul>	LED
Control elements	
Keyboard fonts	
• Design	Touch
Touch operation	
Integrated touch pad	No
Supply voltage	
Design of the power supply	External wide-range power supply; 3-pole
permissible range, lower limit (AC)	100 V; ±10 %, sinusoidal
permissible range, upper limit (AC)	240 V; ±10 %, sinusoidal
Line frequency	
permissible range, lower limit	47 Hz
permissible range, upper limit	63 Hz
Processor	
Processor type	Celeron G3902 (2C/2T, 1.6 GHz, 2 MB cache); Intel Core i5-6442EQ (6 MB
	cache, up to 2.70 GHz, iAMT)
Hyper-threading	No
Turbo Boost Technology 2.0	Yes
Turbo Boost Technology 2.0 Graphic	Yes
	Yes Intel® HD graphics 530
Graphic	
Graphic Graphics controller	
Graphic Graphics controller Drives	Intel® HD graphics 530
Graphic Graphics controller Drives SSD	Intel® HD graphics 530 Yes
Graphic Graphics controller Drives SSD • Memory capacity	Intel® HD graphics 530 Yes 256 Gbyte; Up to 512 GB SSD
Graphic Graphics controller Drives SSD • Memory capacity TPM Security Chip	Intel® HD graphics 530 Yes 256 Gbyte; Up to 512 GB SSD
Graphic Graphics controller Drives SSD • Memory capacity TPM Security Chip Memory	Intel® HD graphics 530 Yes 256 Gbyte; Up to 512 GB SSD Yes
Graphic Graphics controller Drives SSD • Memory capacity TPM Security Chip Memory Type of memory	Intel® HD graphics 530         Yes         256 Gbyte; Up to 512 GB SSD         Yes         DDR4-SDRAM SO-DIMM
Graphic Graphics controller Drives SSD • Memory capacity TPM Security Chip Memory Type of memory Work memory	Intel® HD graphics 530 Yes 256 Gbyte; Up to 512 GB SSD Yes
Graphic Graphics controller Drives SSD • Memory capacity TPM Security Chip Memory Type of memory Work memory • integrated Accumulator	Intel® HD graphics 530 Yes 256 Gbyte; Up to 512 GB SSD Yes DDR4-SDRAM SO-DIMM 4 Gbyte; 8 GB or 16 GB
Graphic Graphics controller Drives SSD • Memory capacity TPM Security Chip Memory Type of memory Work memory • integrated Accumulator Replaceable	Intel® HD graphics 530         Yes         256 Gbyte; Up to 512 GB SSD         Yes         DDR4-SDRAM SO-DIMM
Graphic         Graphics controller         Drives         SSD         • Memory capacity         TPM Security Chip         Memory         Type of memory         • integrated         Accumulator         Replaceable         Capacity	Intel® HD graphics 530         Yes         256 Gbyte; Up to 512 GB SSD         Yes         DDR4-SDRAM SO-DIMM         4 Gbyte; 8 GB or 16 GB         Yes; Lithium-ion battery         5 900 mA-h
Graphic         Graphics controller         Drives         SSD         • Memory capacity         TPM Security Chip         Memory         Type of memory         Work memory         • integrated         Accumulator         Replaceable         Capacity         Battery runtime, min.	Intel® HD graphics 530         Yes         256 Gbyte; Up to 512 GB SSD         Yes         DDR4-SDRAM SO-DIMM         4 Gbyte; 8 GB or 16 GB         Yes; Lithium-ion battery
Graphic         Graphics controller         Drives         SSD         • Memory capacity         TPM Security Chip         Memory         Type of memory         Work memory         • integrated         Accumulator         Replaceable         Capacity         Battery runtime, min.         Interfaces	Intel® HD graphics 530         Yes         256 Gbyte; Up to 512 GB SSD         Yes         DDR4-SDRAM SO-DIMM         4 Gbyte; 8 GB or 16 GB         Yes; Lithium-ion battery         5 900 mA-h         6 h; According to MobileMark 2014
Graphic         Graphics controller         Drives         SSD         • Memory capacity         TPM Security Chip         Memory         Type of memory         Work memory         • integrated         Accumulator         Replaceable         Capacity         Battery runtime, min.         Interfaces         Number of industrial Ethernet interfaces	Intel® HD graphics 530         Yes         256 Gbyte; Up to 512 GB SSD         Yes         DDR4-SDRAM SO-DIMM         4 Gbyte; 8 GB or 16 GB         Yes; Lithium-ion battery         5 900 mA-h         6 h; According to MobileMark 2014         1
Graphic         Graphics controller         Drives         SSD         • Memory capacity         TPM Security Chip         Memory         Type of memory         Work memory         • integrated         Accumulator         Replaceable         Capacity         Battery runtime, min.         Interfaces         Number of industrial Ethernet interfaces         Number of RS 232 interfaces	Intel® HD graphics 530         Yes         256 Gbyte; Up to 512 GB SSD         Yes         DDR4-SDRAM SO-DIMM         4 Gbyte; 8 GB or 16 GB         Yes; Lithium-ion battery         5 900 mA·h         6 h; According to MobileMark 2014         1         1
Graphic         Graphics controller         Drives         SSD         • Memory capacity         TPM Security Chip         Memory         Type of memory         Work memory         • integrated         Accumulator         Replaceable         Capacity         Battery runtime, min.         Interfaces         Number of industrial Ethernet interfaces         Number of RS 232 interfaces         Number of USB interfaces	Intel® HD graphics 530         Yes         256 Gbyte; Up to 512 GB SSD         Yes         DDR4-SDRAM SO-DIMM         4 Gbyte; 8 GB or 16 GB         Yes; Lithium-ion battery         5 900 mA-h         6 h; According to MobileMark 2014         1         1         3; USB 3.0
Graphic         Graphics controller         Drives         SSD         • Memory capacity         TPM Security Chip         Memory         Type of memory         Work memory         • integrated         Accumulator         Replaceable         Capacity         Battery runtime, min.         Interfaces         Number of industrial Ethernet interfaces         Number of RS 232 interfaces	Intel® HD graphics 530         Yes         256 Gbyte; Up to 512 GB SSD         Yes         DDR4-SDRAM SO-DIMM         4 Gbyte; 8 GB or 16 GB         Yes; Lithium-ion battery         5 900 mA·h         6 h; According to MobileMark 2014         1         1

Bluetooth radio standard	Yes; V4.0
Multimedia card/SD card slot	2 in 1 (SDHC UHS-II, MMC)
Universal Audio Jack	Yes; Audio socket for 3.5 mm jack
Video interfaces	
DisplayPort	Yes; DP 1.2 (Mini DisplayPort)
Industrial Ethernet	
Industrial Ethernet interface	1x Ethorpot (P 145)
	1x Ethernet (RJ45)
— 100 Mbps	Yes
— 1000 Mbps	
IAMT (Intel Active Management Technology)	Yes
WLAN	
• Туре	IEEE 802.11 a/b/g/n and ac
Wireless transmission	
Protocol for wireless transmission	Legic Prime, Legic Advant, ISO 15693, ISO 14443 A/B
Operating frequency (rated value)	13.56 MHz
Range, max.	30 mm; Range depends on transponder
Interrupts/diagnostics/status information	
LED status display	Battery charge level, device status, access to drive, WLAN active, SD card,
ENC	application LED
EMC	
Interference immunity against discharge of static electricity	
<ul> <li>Interference immunity against discharge of static electricity acc. to IEC 61000-4-2</li> </ul>	Yes; ±4 kV contact discharge (to IEC 801-2/IEC 1000-4-2; ESD), ±8 kV air discharge (to IEC 801-2/IEC 1000-4-2; ESD)
Interference immunity to cable-borne interference	disonalys (10 120 00 1-21120 1000-4-2, ESD)
Interference immunity to cable-borne interference     Interference immunity on supply cables	±2 kV (according to IEC 61000-4-4, burst); ±1 kV (according to IEC 61000-4-5,
Interference infinunity on supply cables	surge pulse/line to line); ±2 kV (according to IEC 61000-4-5, surge pulse/line to ground)
• Interference immunity on signal cables	$\pm$ 1 kV (according to IEC 61000-4-4, burst, length < 30 m); $\pm$ 2 kV (according to IEC 61000-4-4, burst, length > 30 m); $\pm$ 2 kV (according to IEC 61000-4-5, surge
Degree and class of protection	sym./line to ground, length > 30 m)
IP degree of protection	IP40
	IF 40
Standards, approvals, certificates	V
CE mark	Yes
UL approval	Yes
DIN/ISO 9001	Yes
Military use	
Conforms to MIL-STD-810G	Yes
Ambient conditions	
Ambient temperature during operation	
• min.	5 °C; Max. 10 °C/h (no condensation)
• max.	45 °C; Max. 10 °C/h (no condensation)
Ambient temperature during storage/transportation	
• min.	-20 °C; Max. 20 °C/h (no condensation)
• max.	60 °C; Max. 20 °C/h (no condensation)
Relative humidity	
Operation, min.	5 %; At 30 °C/h (no condensation); Tested according to IEC 60068-2-78, IEC
• Operation, max.	60068-2-30, IEC 60068-2-14 85 %; At 30 °C/h (no condensation); Tested according to IEC 60068-2-78, IEC
Vibrationa	60068-2-30, IEC 60068-2-14
Vibrations	
Operation, tested according to IEC 60068-2-6	Yes
Shock testing	
tested according to IEC 60068-2-27	Yes
Operating systems	
Local language of operating system	Multi-Language User Interface (MUI): 6 languages (English, German, French, Spanish, Italian, Chinese)
pre-installed operating system	
Windows 7	Yes; Ultimate 64 bit, SP1
Windows 10	Yes; Windows 10 Enterprise 2016 LTSB, 64 bit, MUI
Software	
Preinstalled	
Preinstalled • STEP 7 Professional 2010	Νο

<ul> <li>STEP 7 Professional (TIA Portal)</li> </ul>	No
• STEP 7	No
<ul> <li>WinCC flexible Advanced 2008</li> </ul>	No
<ul> <li>WinCC Advanced (TIA Portal)</li> </ul>	No
• STEP 5	No
Mechanics/material	
Material of housing	metal
Magnesium alloy	Yes
Socket for Kensington lock	Yes
rubber corner guards	Yes
Dimensions	
Width	330 mm
Height	32 mm
Depth	214 mm
Weights	
Weight, approx.	1.6 kg; incl. rechargeable battery
Scope of supply	
Accumulator	Yes
Power supply	Yes
Recovery media	Yes; Restore & Recovery
Other	
free hotline	Yes
Note:	Made in Germany: development and production in Germany

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